

TRENCHSTOP™ 5 WR6 technology in enhanced creepage and clearance package offers improved reliability against package contamination

Features

- $V_{CE} = 650\text{ V}$
- $I_C = 30\text{ A}$
- Pin-to-pin creepage distance > 4.8 mm
- Pin-to-pin clearance distance > 3.4 mm
- Monolithic diode optimized for PFC and welding applications
- Stable temperature behavior
- Very low V_{CEsat} and low E_{off}
- Easy parallel switching capability based on positive temperature coefficient of V_{CEsat}
- Low temperature dependence of V_{CEsat} and E_{sw}
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

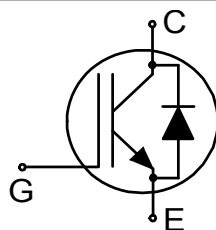
- PFC
- Welding
- ZCS applications

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



Description



Type	Package	Marking
IKWH30N65WR6	PG-TO247-3-STD-NN4.8	H30EWR6



Table of contents

	Description	1
	Features	1
	Potential applications	1
	Product validation	1
	Table of contents	2
1	Package	3
2	IGBT	3
3	Diode	5
4	Characteristics diagrams	7
5	Package outlines	14
6	Testing conditions	15
	Revision history	16
	Disclaimer	17

1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting process: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$				0.9	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				4.2	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$		650	V
DC collector current, limited by T_{vjmax}	I_C		$T_c = 25\text{ °C}$	67	A
			$T_c = 100\text{ °C}$	42	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			90	A
Turn-off safe operating area		$V_{CE} \leq 650\text{ V}, T_{vj} \leq 175\text{ °C}$		90	A
Gate-emitter voltage	V_{GE}			± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 10\text{ }\mu\text{s}, D < 0.01$		± 30	V
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	165	W
			$T_c = 100\text{ °C}$	83	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	V_{BRCES}	$I_C = 0.2\text{ mA}, V_{GE} = 0\text{ V}$	650			V

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 30\text{ A}$, $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		1.45	1.75	V
			$T_{vj} = 175\text{ °C}$		1.7		
Gate-emitter threshold voltage	V_{GETh}	$I_C = 0.3\text{ mA}$, $V_{CE} = V_{GE}$		3.2	4	4.8	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 650\text{ V}$, $V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$			40	μA
			$T_{vj} = 175\text{ °C}$		0.5		mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$				100	nA
Transconductance	g_{fs}	$I_C = 30\text{ A}$, $V_{CE} = 20\text{ V}$			75		S
Input capacitance	C_{ies}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			2700		pF
Output capacitance	C_{oes}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			27		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			11		pF
Gate charge	Q_G	$I_C = 30\text{ A}$, $V_{GE} = 15\text{ V}$, $V_{CC} = 520\text{ V}$			111		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 23\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 30\text{ A}$		35		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 30\text{ A}$		31		
Rise time (inductive load)	t_r	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 23\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 30\text{ A}$		18		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 30\text{ A}$		20		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 23\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 30\text{ A}$		334		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 30\text{ A}$		375		
Fall time (inductive load)	t_f	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 23\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 30\text{ A}$		16		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 30\text{ A}$		16		
Turn-on energy	E_{on}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 23\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 30\text{ A}$		0.82		mJ
			$T_{vj} = 175\text{ °C}$, $I_C = 30\text{ A}$		0.92		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy	E_{off}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\ \Omega$, $R_{G(off)} = 27\ \Omega$, $L_{\sigma} = 30\text{ nH}$, $C_{\sigma} = 23\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 30\text{ A}$	0.38		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 30\text{ A}$	0.63		
Total switching energy	E_{ts}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\ \Omega$, $R_{G(off)} = 27\ \Omega$, $L_{\sigma} = 30\text{ nH}$, $C_{\sigma} = 23\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 30\text{ A}$	1.2		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 30\text{ A}$	1.55		
Operating junction temperature	T_{vj}		-40		175	$^{\circ}\text{C}$

Note: Electrical Characteristic, at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	650	V
Diode forward current, limited by T_{vjmax}	I_F	$T_c = 25\text{ }^{\circ}\text{C}$	20	A
		$T_c = 100\text{ }^{\circ}\text{C}$	11	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		30	A

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 10\text{ A}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$	1.3	1.6	V
			$T_{vj} = 175\text{ }^{\circ}\text{C}$	1.35		
Diode reverse recovery time	t_{rr}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1460\text{ A}/\mu\text{s}$	82		ns
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1400\text{ A}/\mu\text{s}$	94		

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode reverse recovery charge	Q_{rr}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1460\text{ A/}\mu\text{s}$		1.4		μC
			$T_{vj} = 175\text{ °C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1400\text{ A/}\mu\text{s}$		2.2		
Diode peak reverse recovery current	I_{rrm}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1460\text{ A/}\mu\text{s}$		24		A
			$T_{vj} = 175\text{ °C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1400\text{ A/}\mu\text{s}$		28.8		
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1460\text{ A/}\mu\text{s}$		700		A/ μs
			$T_{vj} = 175\text{ °C}$, $I_F = 15\text{ A}$, $-di_F/dt = 1400\text{ A/}\mu\text{s}$		830		
Operating junction temperature	T_{vj}			-40		175	$^{\circ}\text{C}$

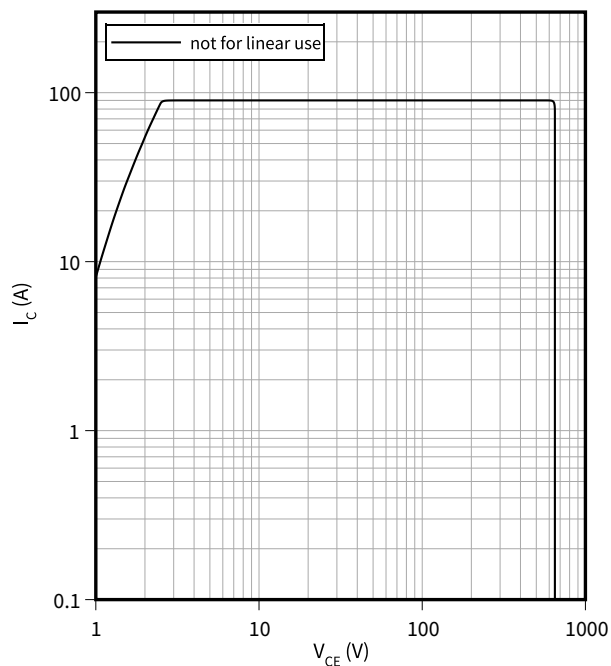
Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

4 Characteristics diagrams

Reverse bias safe operating area

$$I_C = f(V_{CE})$$

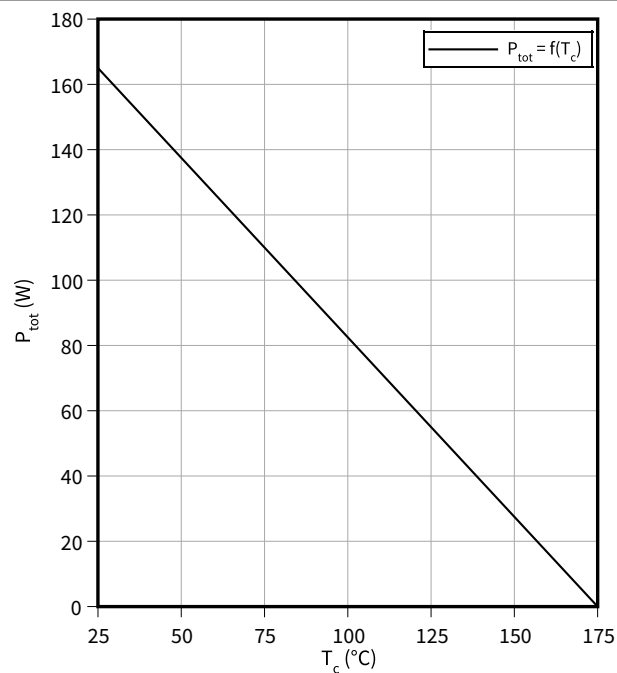
$$T_{vj} \leq 175\text{ °C}, T_c = 25\text{ °C}, V_{GE} = 15\text{ V}$$



Power dissipation as a function of case temperature

$$P_{tot} = f(T_c)$$

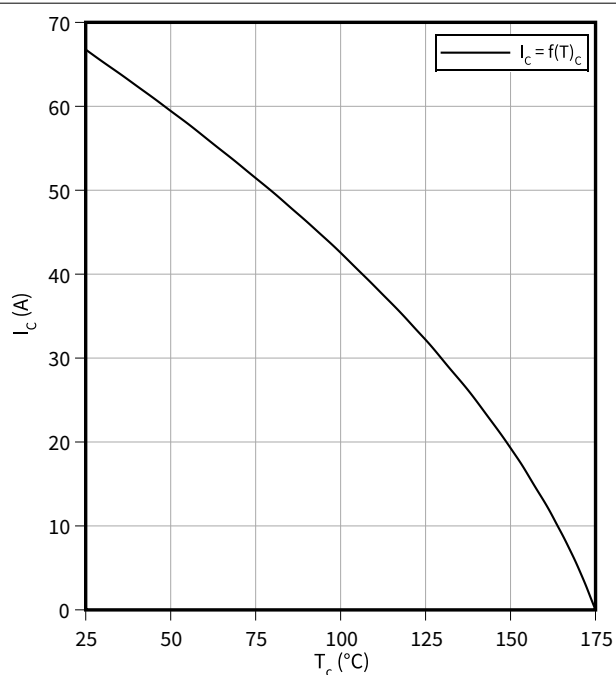
$$T_{vj} \leq 175\text{ °C}$$



Collector current as a function of case temperature

$$I_C = f(T_c)$$

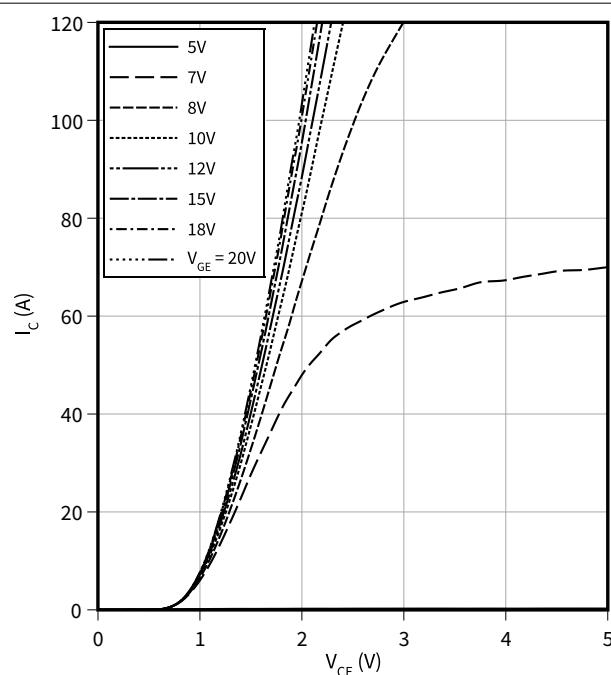
$$T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$$



Typical output characteristic

$$I_C = f(V_{CE})$$

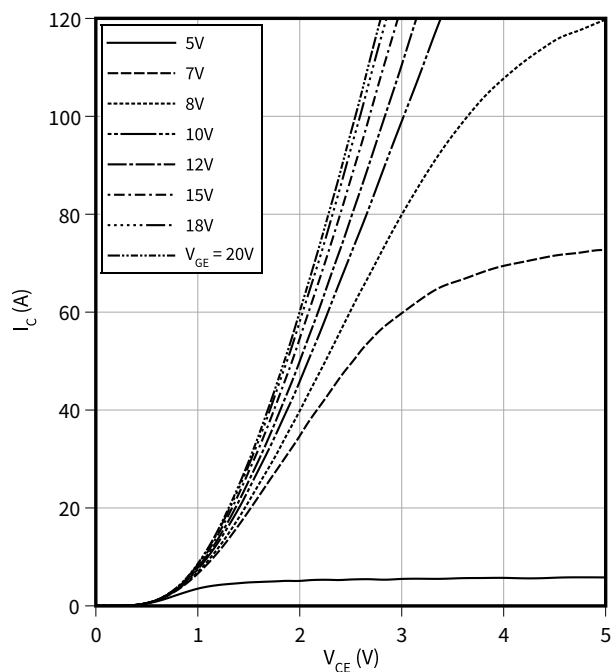
$$T_{vj} = 25\text{ °C}$$



Typical output characteristic

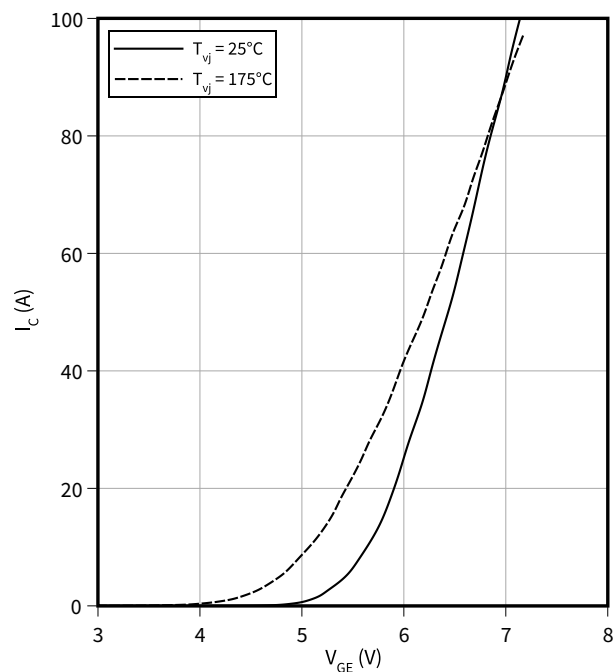
$$I_C = f(V_{CE})$$

$$T_{vj} = 175\text{ }^{\circ}\text{C}$$

**Typical transfer characteristic**

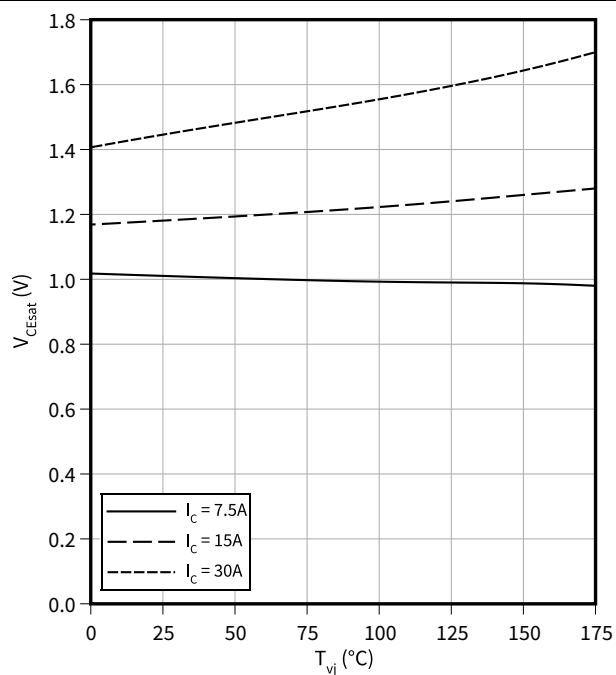
$$I_C = f(V_{GE})$$

$$V_{CE} = 20\text{ V}$$

**Typical collector-emitter saturation voltage as a function of junction temperature**

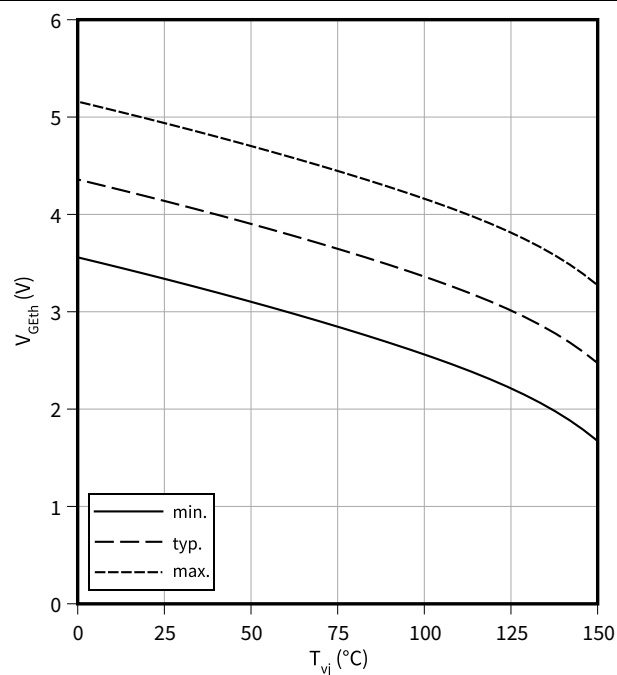
$$V_{CEsat} = f(T_{vj})$$

$$V_{GE} = 15\text{ V}$$

**Gate-emitter threshold voltage as a function of junction temperature**

$$V_{GEth} = f(T_{vj})$$

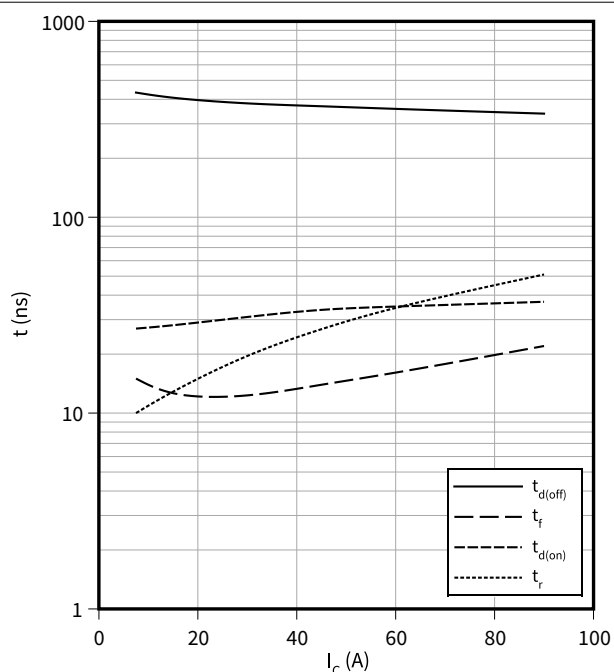
$$I_C = 0.3\text{ mA}$$



Typical switching times as a function of collector current

$$t = f(I_C)$$

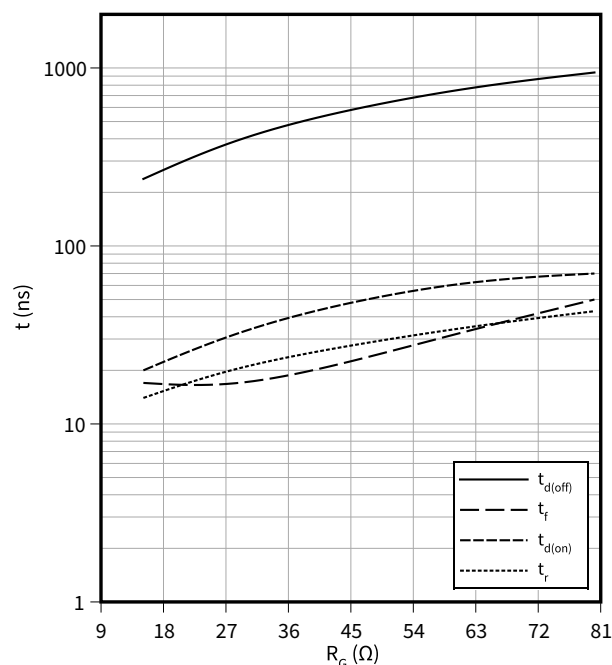
$V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 27 \text{ } \Omega$



Typical switching times as a function of gate resistor

$$t = f(R_G)$$

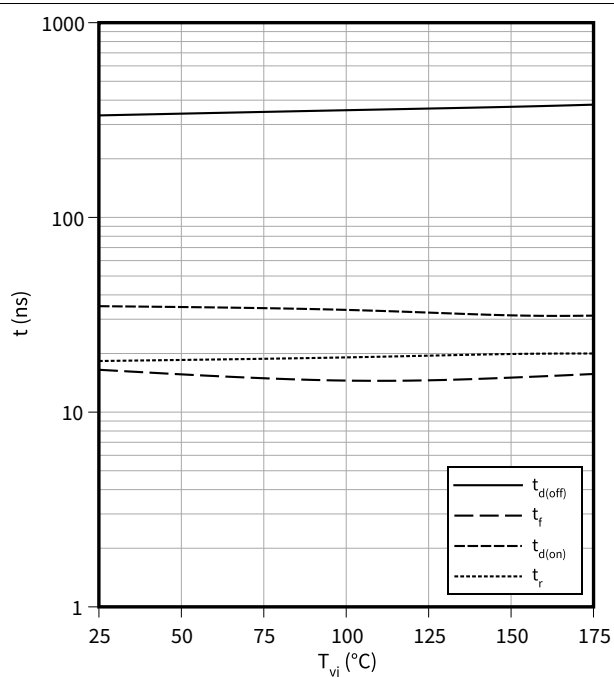
$I_C = 30 \text{ A}$, $V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$



Typical switching times as a function of junction temperature

$$t = f(T_{vj})$$

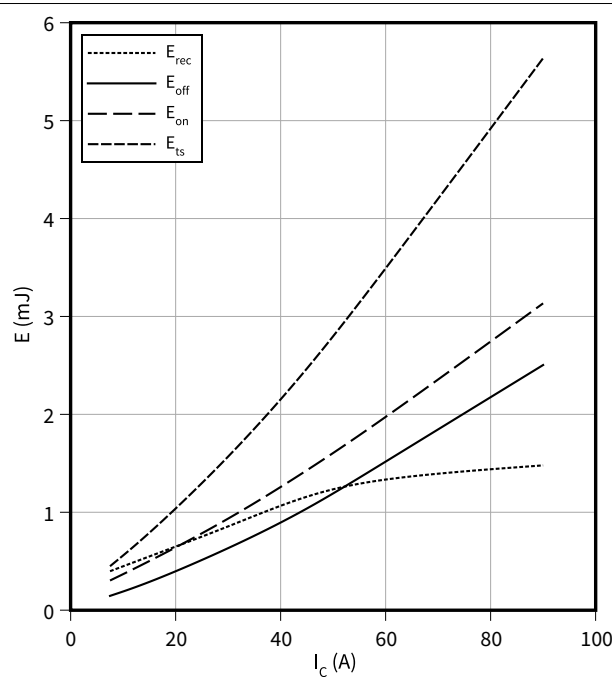
$I_C = 30 \text{ A}$, $V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 27 \text{ } \Omega$



Typical switching energy losses as a function of collector current

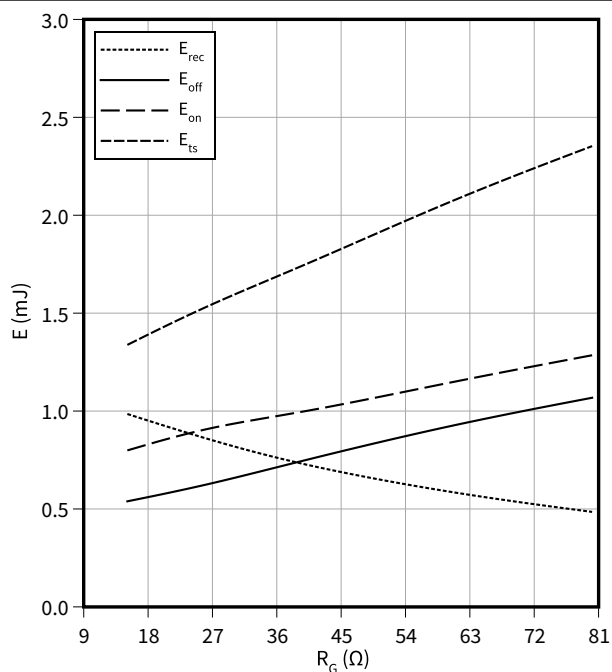
$$E = f(I_C)$$

$V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 27 \text{ } \Omega$



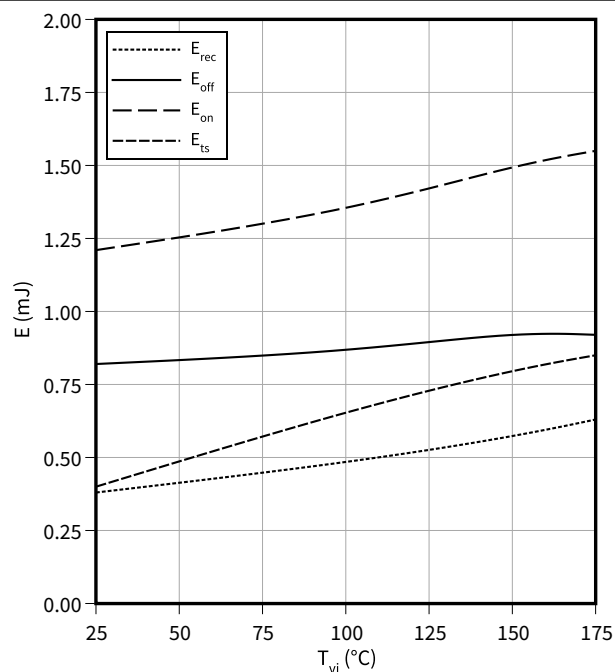
Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$

 $I_C = 30\text{ A}, V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}$


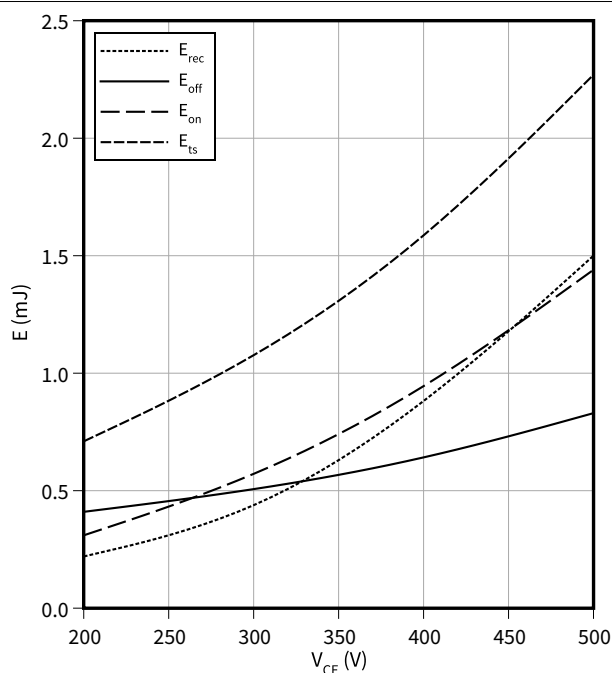
Typical switching energy losses as a function of junction temperature

$$E = f(T_{vj})$$

 $I_C = 30\text{ A}, V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ }\Omega$


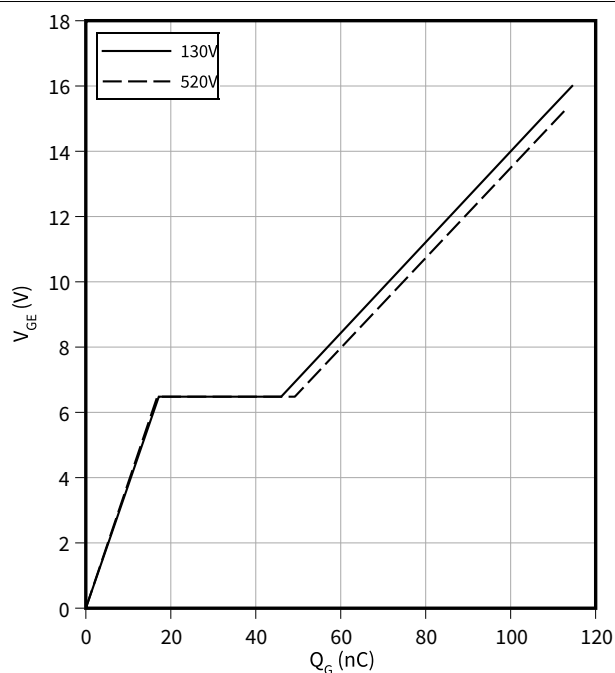
Typical switching energy losses as a function of collector emitter voltage

$$E = f(V_{CE})$$

 $I_C = 30\text{ A}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ }\Omega$


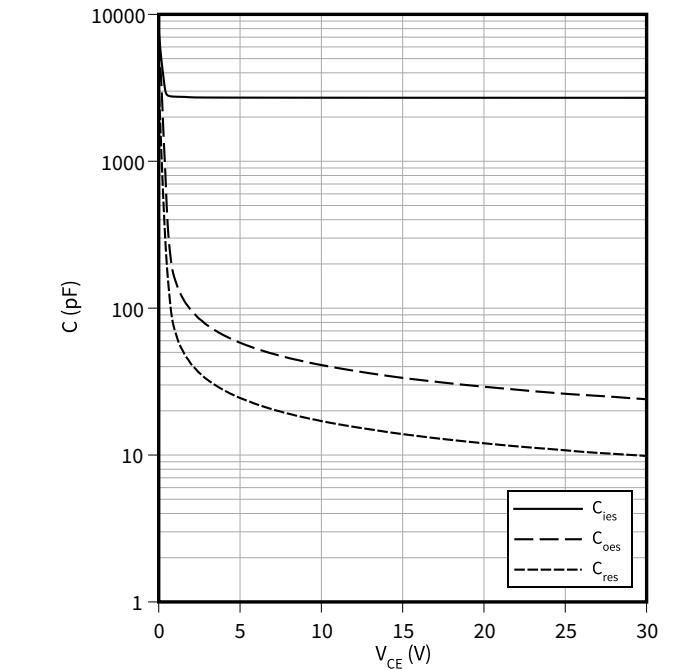
Typical gate charge

$$V_{GE} = f(Q_G)$$

 $I_C = 30\text{ A}$


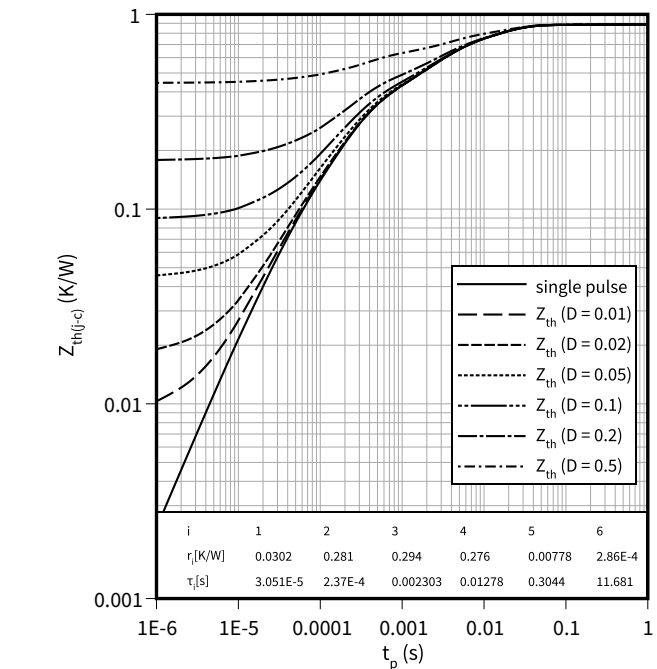
Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$
 $f = 100\text{ kHz}, V_{GE} = 0\text{ V}$



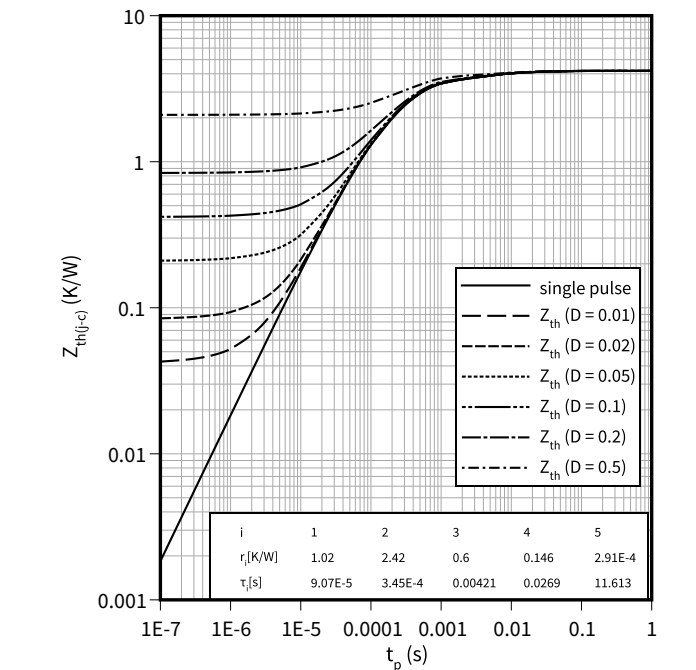
IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
 $D = t_p/T$



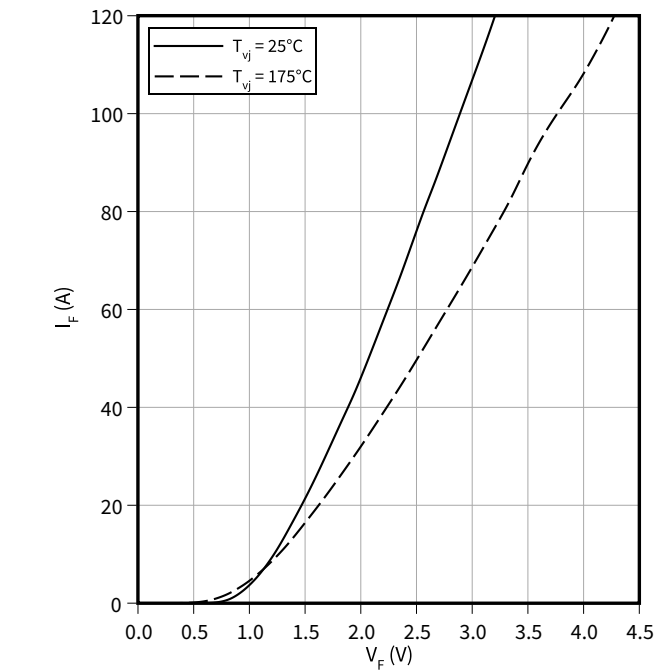
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
 $D = t_p/T$



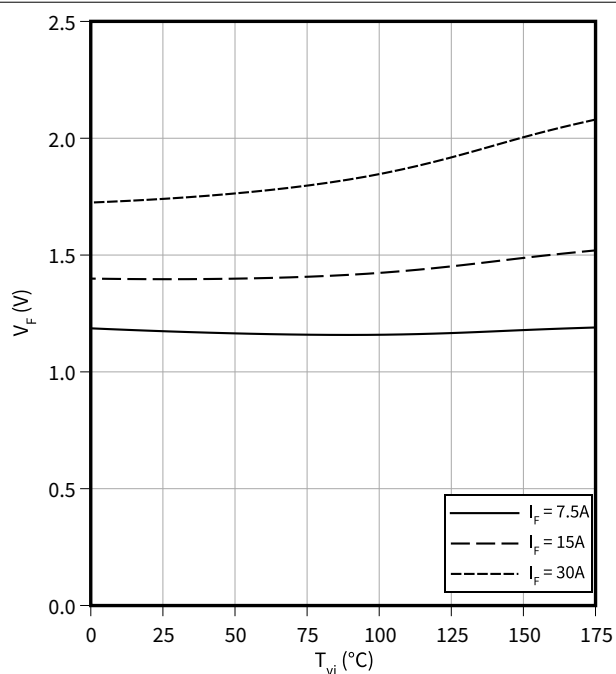
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



Typical diode forward voltage as a function of junction temperature

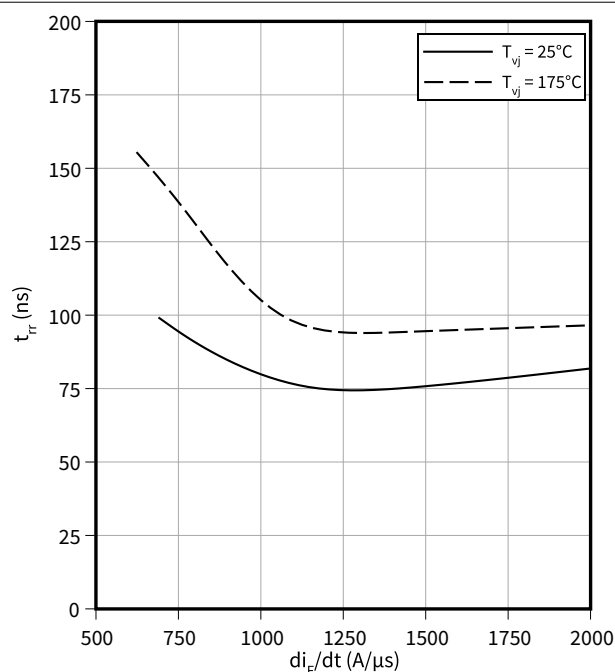
$$V_F = f(T_{vj})$$



Typical reverse recovery time as a function of diode current slope

$$t_{rr} = f(di_F/dt)$$

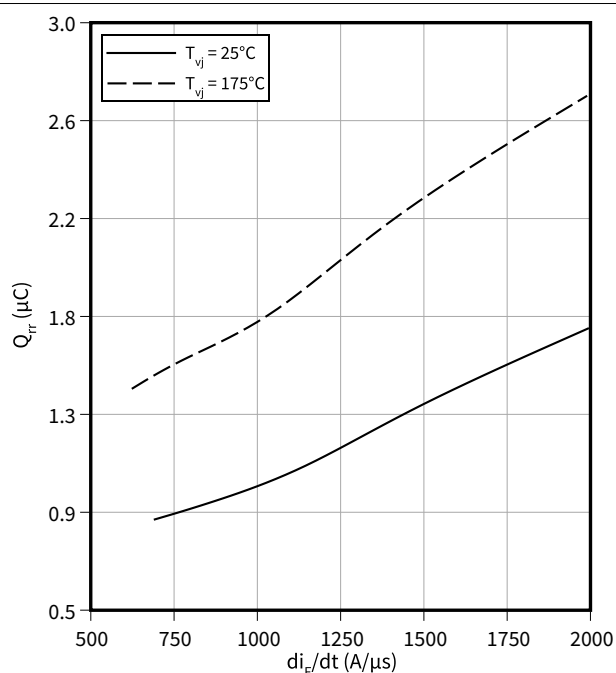
$$V_R = 400 V, I_F = 15 A$$



Typical reverse recovery charge as a function of diode current slope

$$Q_{rr} = f(di_F/dt)$$

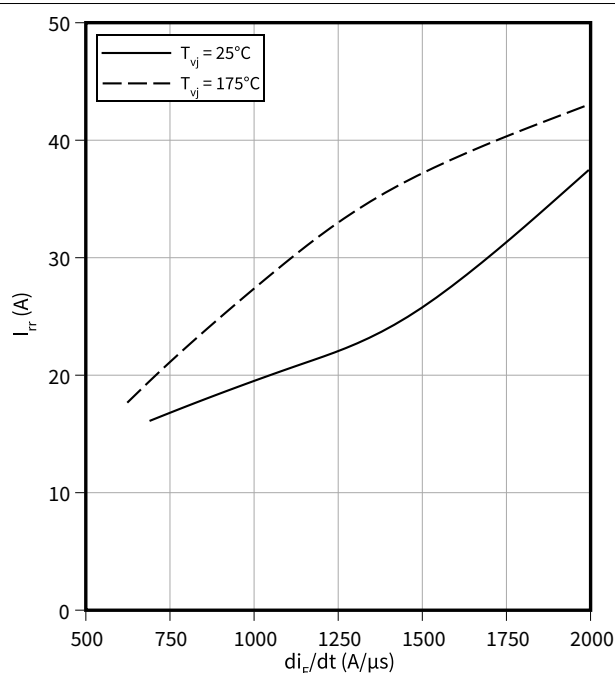
$$V_R = 400 V, I_F = 15 A$$



Typical reverse recovery current as a function of diode current slope

$$I_{rrm} = f(di_F/dt)$$

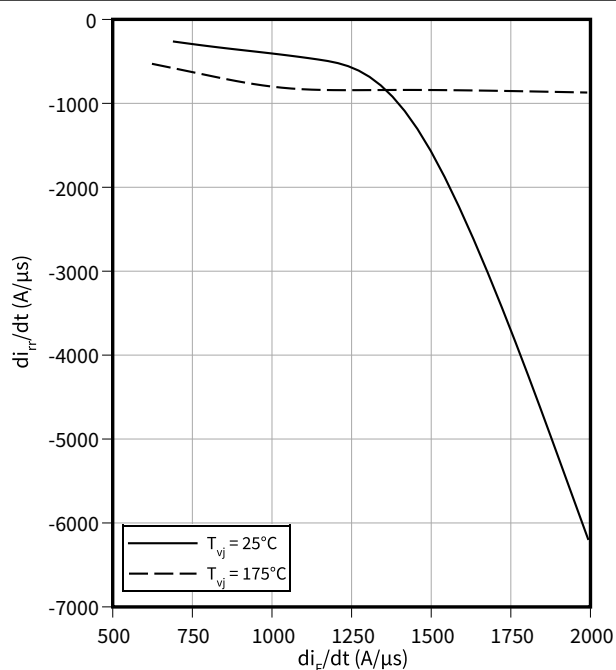
$$V_R = 400 V, I_F = 15 A$$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

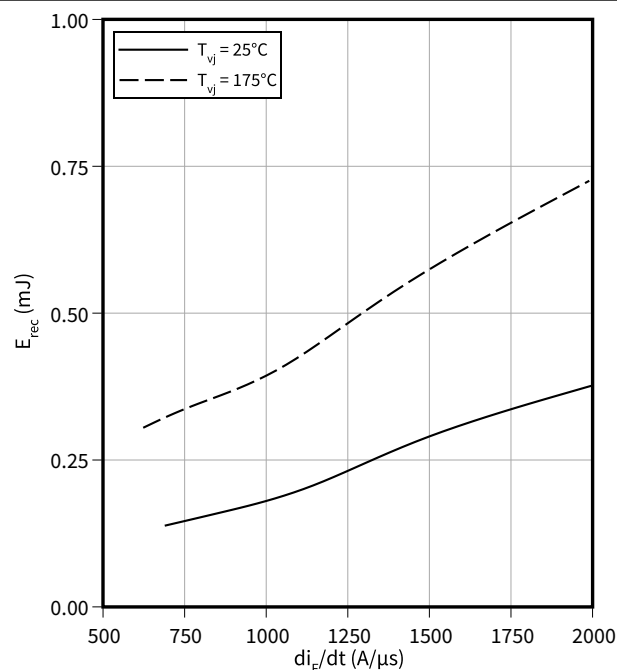
$$di_{rr}/dt = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 15 \text{ A}$$


Typical reverse energy losses as a function of diode current slope

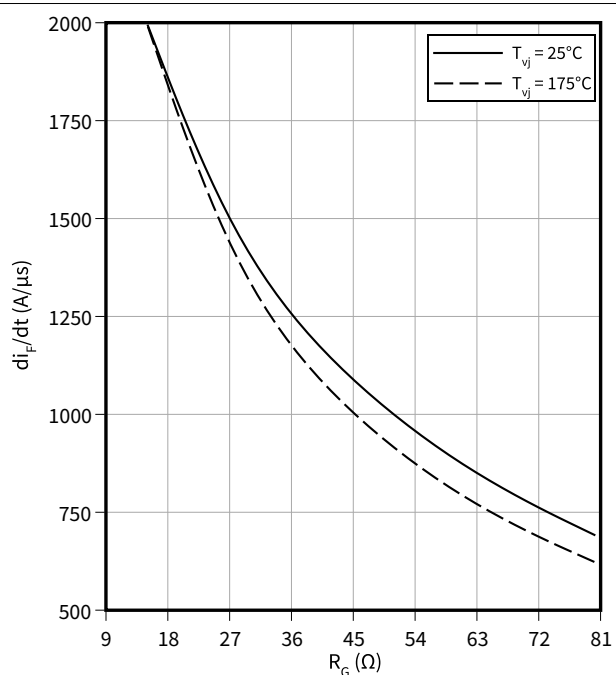
$$E_{rec} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 15 \text{ A}$$


Typical diode current slope as a function of gate resistor

$$di_F/dt = f(R_G)$$

$$V_R = 400 \text{ V}, I_F = 15 \text{ A}$$



5

Package outlines

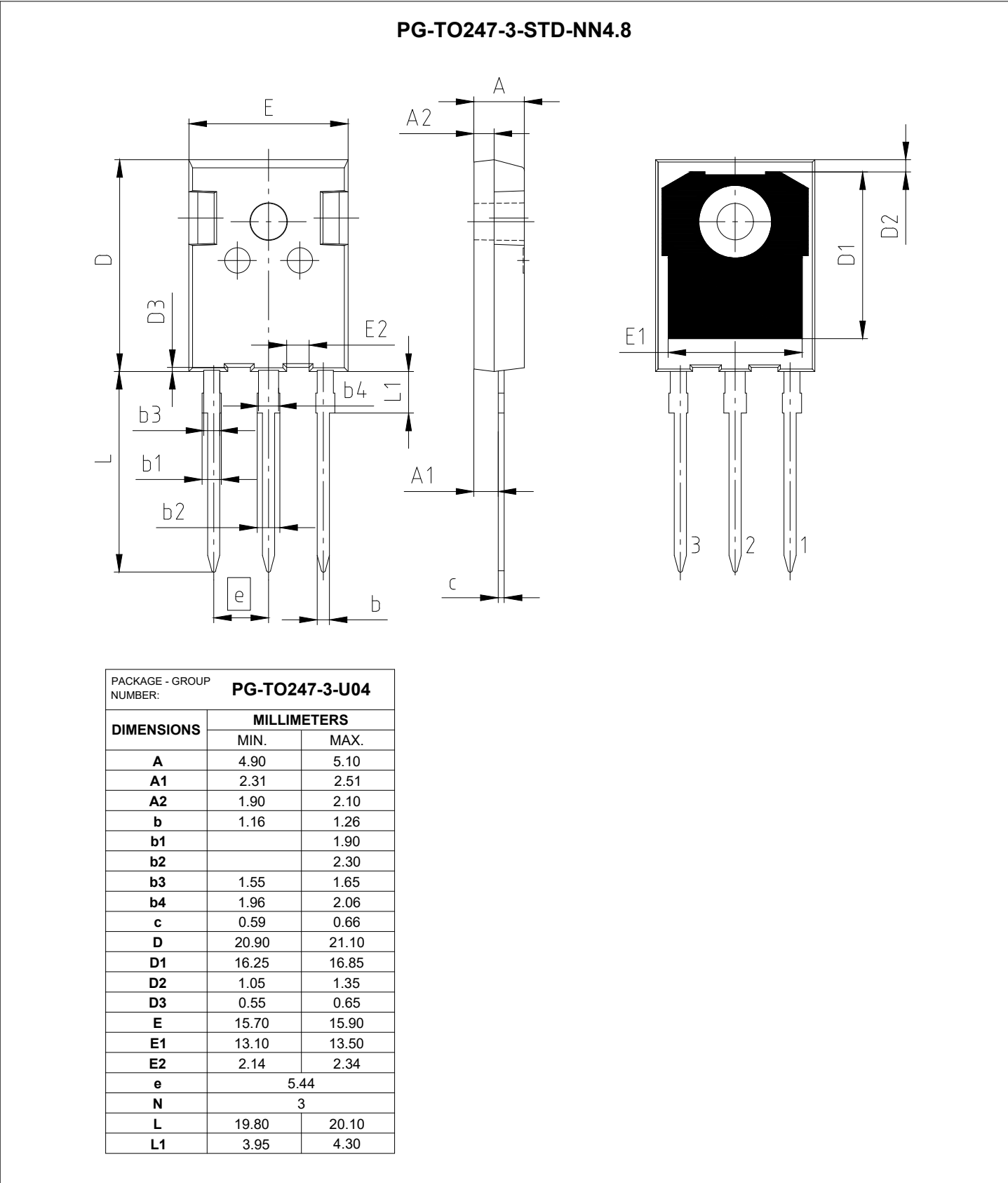


Figure 1

6 Testing conditions

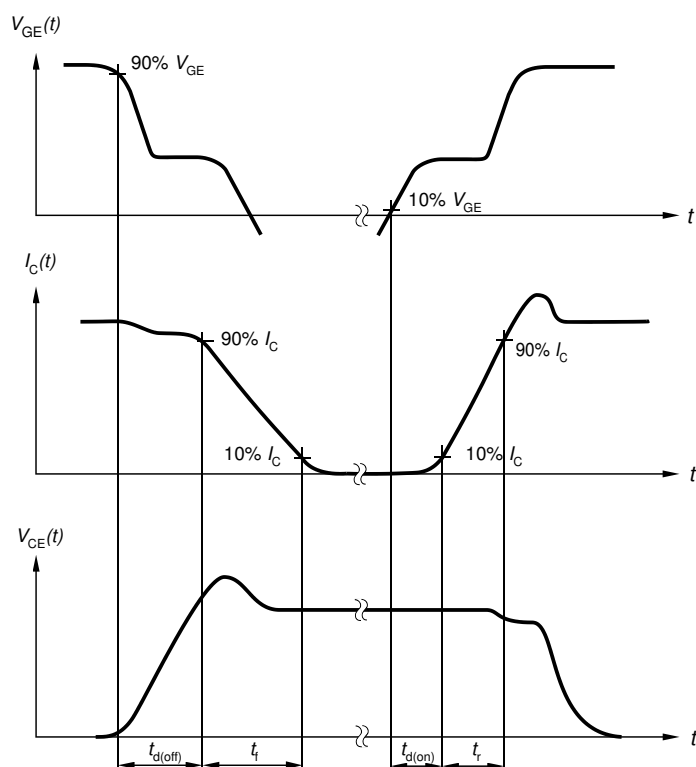


Figure A. Definition of switching times

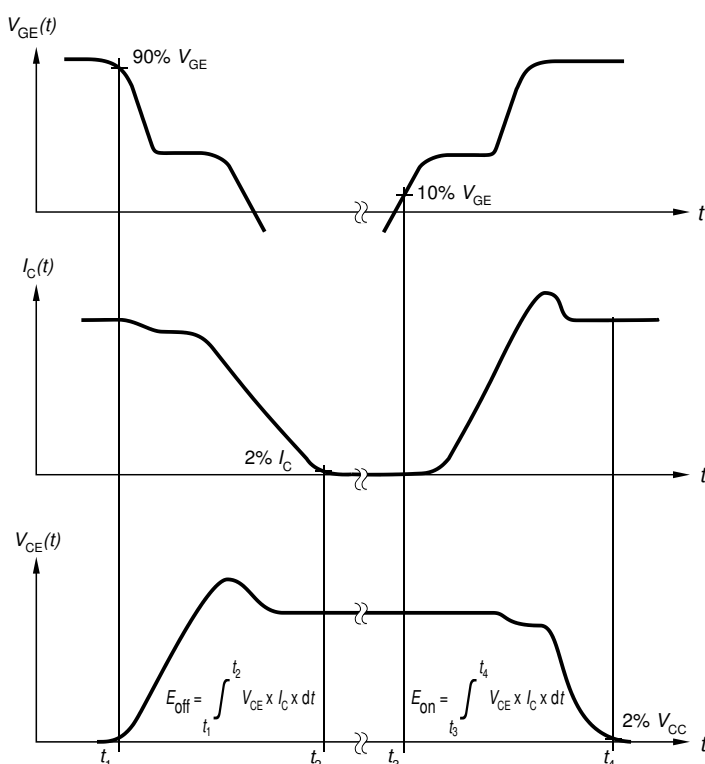


Figure B. Definition of switching losses

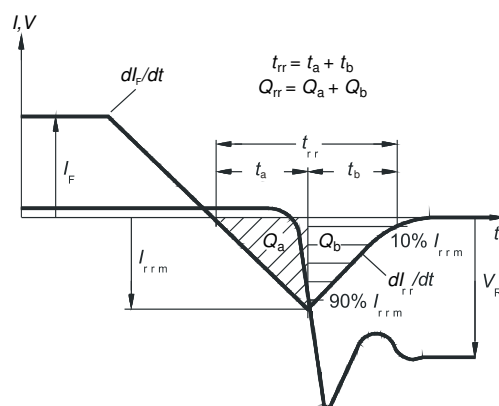


Figure C. Definition of diode switching characteristics

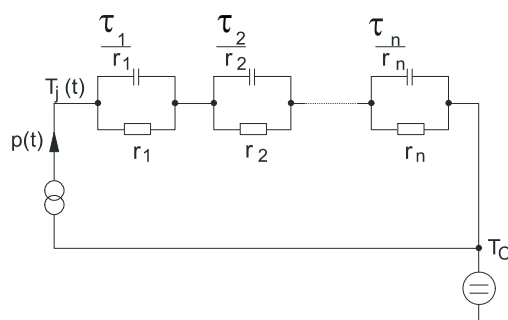


Figure D. Thermal equivalent circuit

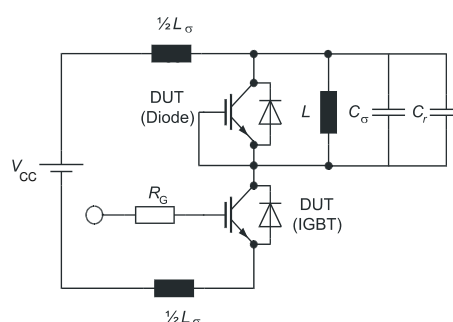


Figure E. Dynamic test circuit
Parasitic inductance L_{σ} ,
parasitic capacitor C_{σ} ,
relief capacitor C_r ,
(only for ZVT switching)

Revision history

Document revision	Date of release	Description of changes
1.00	2021-05-17	Final datasheet
1.10	2021-05-18	Update of diagram $E = f(T_{vj})$
1.20	2021-06-29	Update of diagram $E = f(T_{vj})$
1.30	2022-12-06	Update of “DC collector current, limited by T_{vjmax}” in table “Maximum rated values”, for 25°C and 100°C Transient gate-emitter voltage V_{GE} in table “Maximum rated values” of IGBT changed to $\pm 30V$ Update of diagram “Collector current as a function of case temperature”, $I_C = f(T_c)$ “Forward bias safe operating area” diagram renamed to “Reverse bias safe operating area” Correction of package outline dimensions Change package name to marketing name Editorial changes

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2022-12-06

Published by

Infineon Technologies AG
81726 Munich, Germany

© 2022 Infineon Technologies AG
All Rights Reserved.

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

Document reference
IFX-ABA899-004

Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.